PCN Number:		20230614009.2				PCN Date:		June 1	4, 2023	
Title:		Adding JCB2-PR as additional wafer probe (EWS) site								
Customer Contact:		PCN Manager			•		Quality Se	Quality Services		
Proposed 1 st Ship Date:		Dec 16, 2023		Estimated Sar Availab				ported		
C	Change Type:									
	Assembly Site		ign		Wafer Bump Material					
Assembly Process				a Sheet		Wafer Bump Process			S	
Assembly Material				t number change			afer Fab Site			
Mechanical Specification		_				_	Wafer Fab Material			
L	Packing/Shipping/I		_	t Process	□ Wafer Fab Process					
PCN Details										
Description of Change:										
Texas Instruments Incorporated has qualified JCB2-PR as additional probe (EWS) site for the devices listed below to support high volume ramps. Current: New:										
	Probe Site (EW		JCB1-PR			JCB2-PR				
Test coverage, insertions, conditions will remain consistent with current testing.										
Reason for Change:										
Enable additional probe capacity to support high volume ramps.										
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):										
None.										
Changes to product identification resulting from this PCN:										
Ν	None.									
P	Product Affected:									
	TMCS1100A1QDRQ1	TMCS1101A2UQDRO	Q1	TMCS1107A2BQDRQ	1	TMCS	S1108A1	UQDRQ1		
	TMCS1100A2QDRQ1	TMCS1101A3BQDRC		TMCS1107A2UQDRQ		TMCS	S1108A2	BQDRQ1		
	TMCS1100A3QDRQ1	TMCS1101A3UQDRO	Q1	TMCS1107A3BQDRQ	1	TMCS	S1108A2	UQDRQ1		
	TMCS1100A4QDRQ1	TMCS1101A4BQDRC		TMCS1107A3UQDRQ				BQDRQ1		
	TMCS1101A1BQDRQ1	TMCS1101A4UQDRO		TMCS1107A4BQDRQ				UQDRQ1		
	TMCS1101A1UQDRQ1	TMCS1107A1BQDRC		TMCS1107A4UQDRQ				BQDRQ1		
	TMCS1101A2BQDRQ1	TMCS1107A1UQDRO		TMCS1108A1BQDRQ				UQDRQ1		

ZVEI ID: SEM-TF-01

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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